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(12) **United States Design Patent**  
**Quek**

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(54) **HEADPHONES**

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D14/206, 223; 181/129, 130, 131; 379/430,  
379/431; 381/380, 381, 385; 455/90.3, 575.1,  
455/569.1

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for headphones, as shown and  
described.

**DESCRIPTION**

FIG. 1 is a perspective view of a headphones showing my new  
design;

FIG. 2 is a top plan view thereof;

FIG. 3 is a front elevational view thereof;

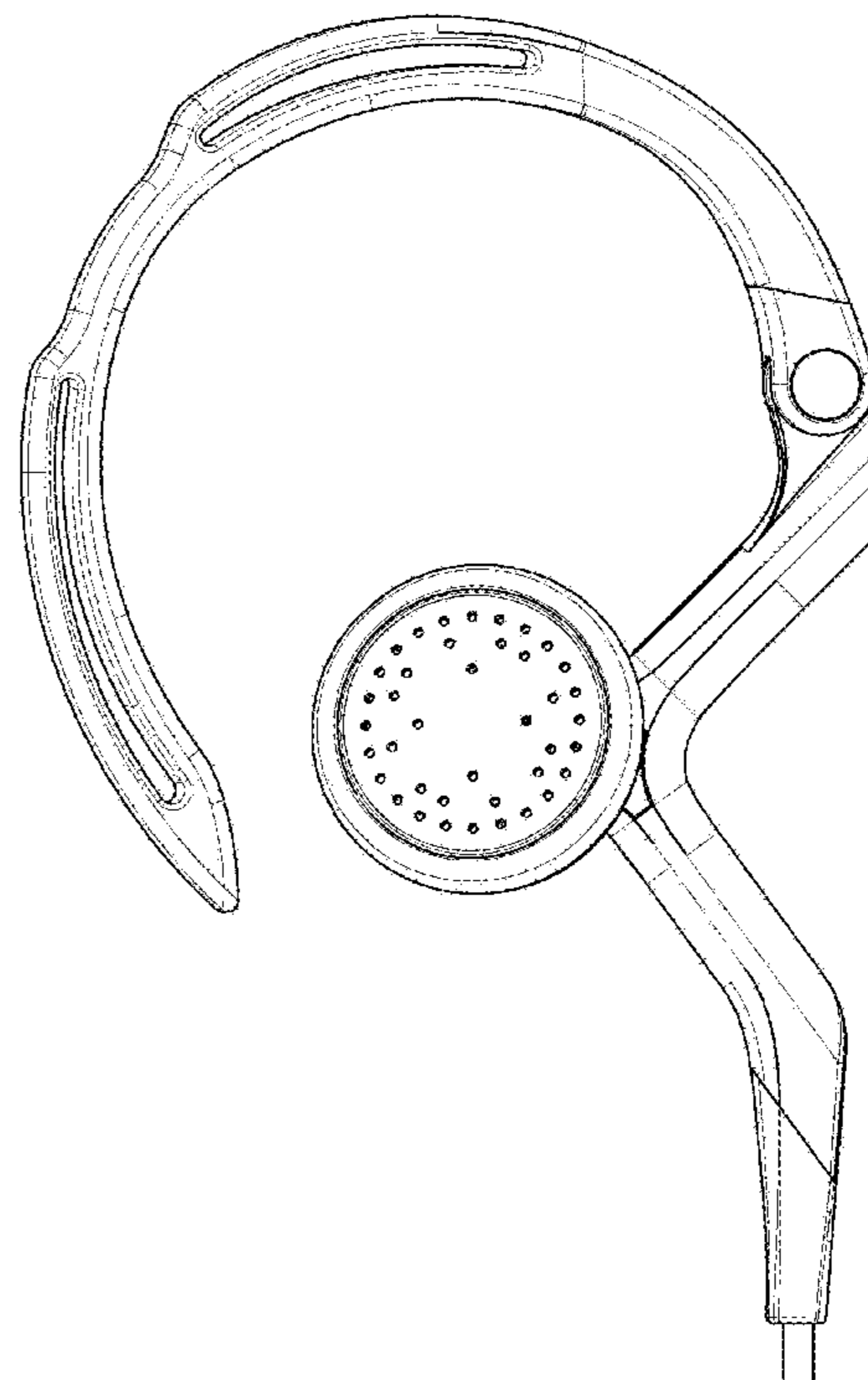
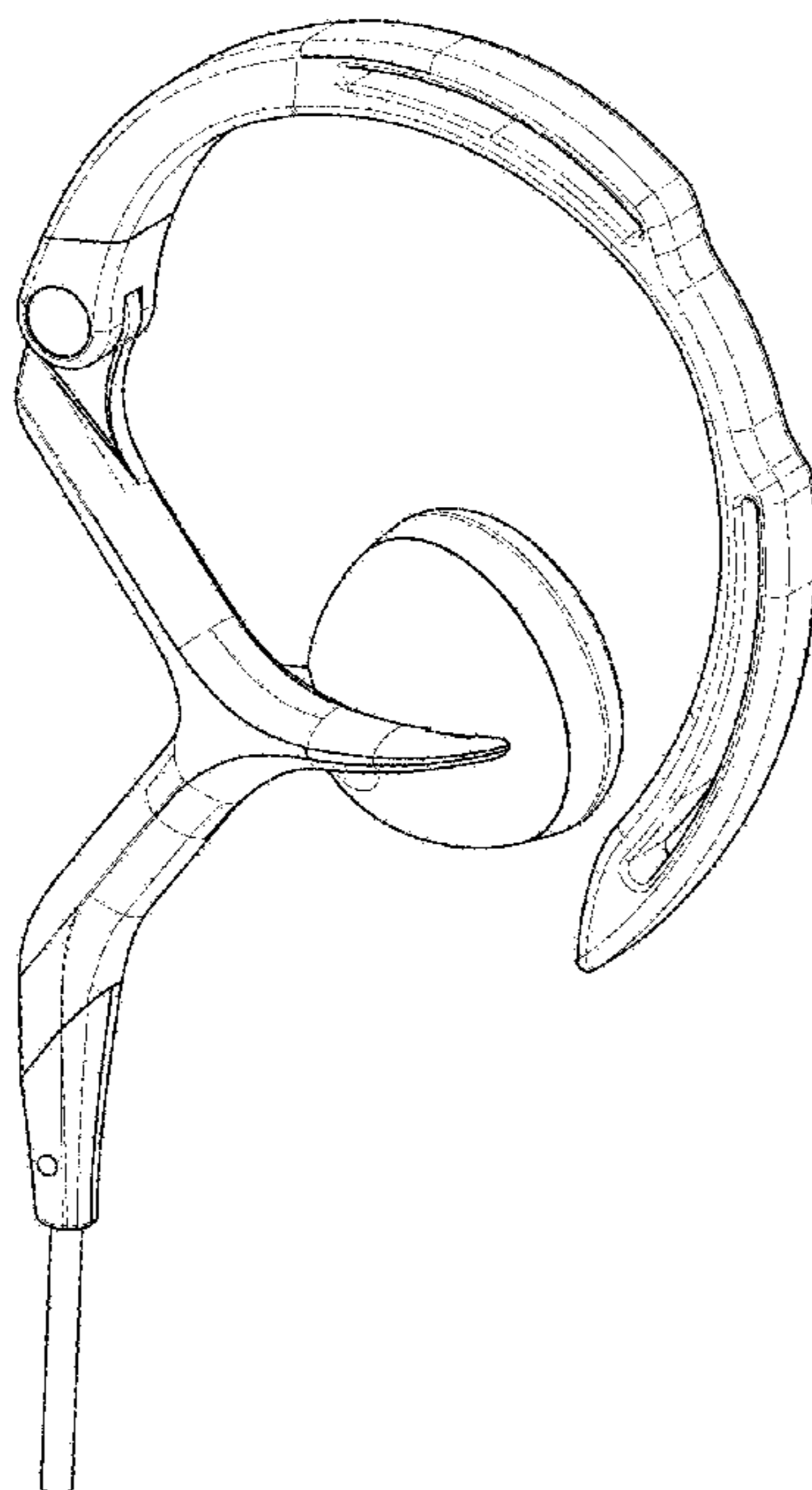
FIG. 4 is a right side elevational view thereof;

FIG. 5 is a rear elevational view thereof;

FIG. 6 is a bottom plan view thereof; and,

FIG. 7 is a left side elevational view thereof.

**1 Claim, 7 Drawing Sheets**



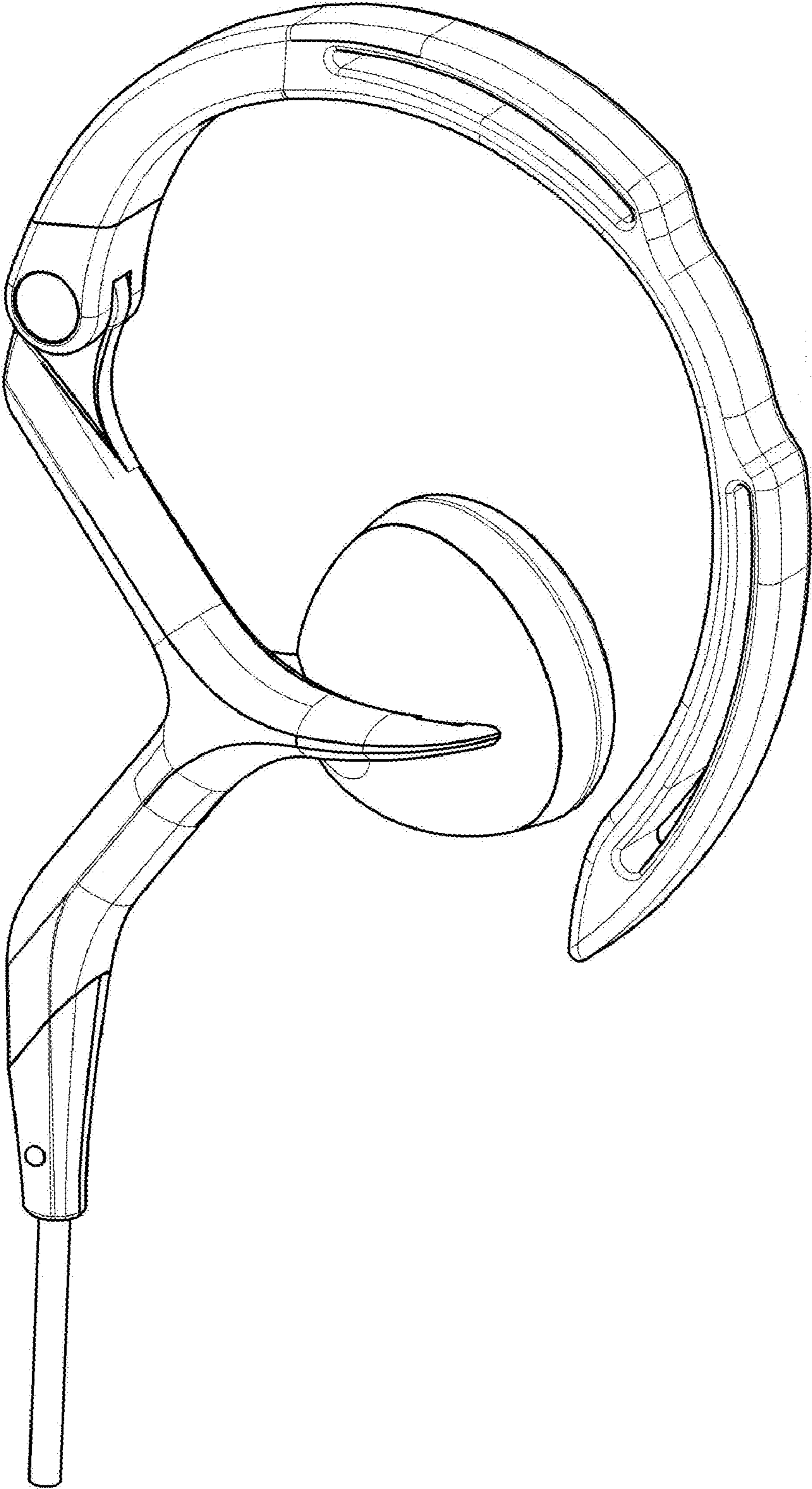


FIG. 1

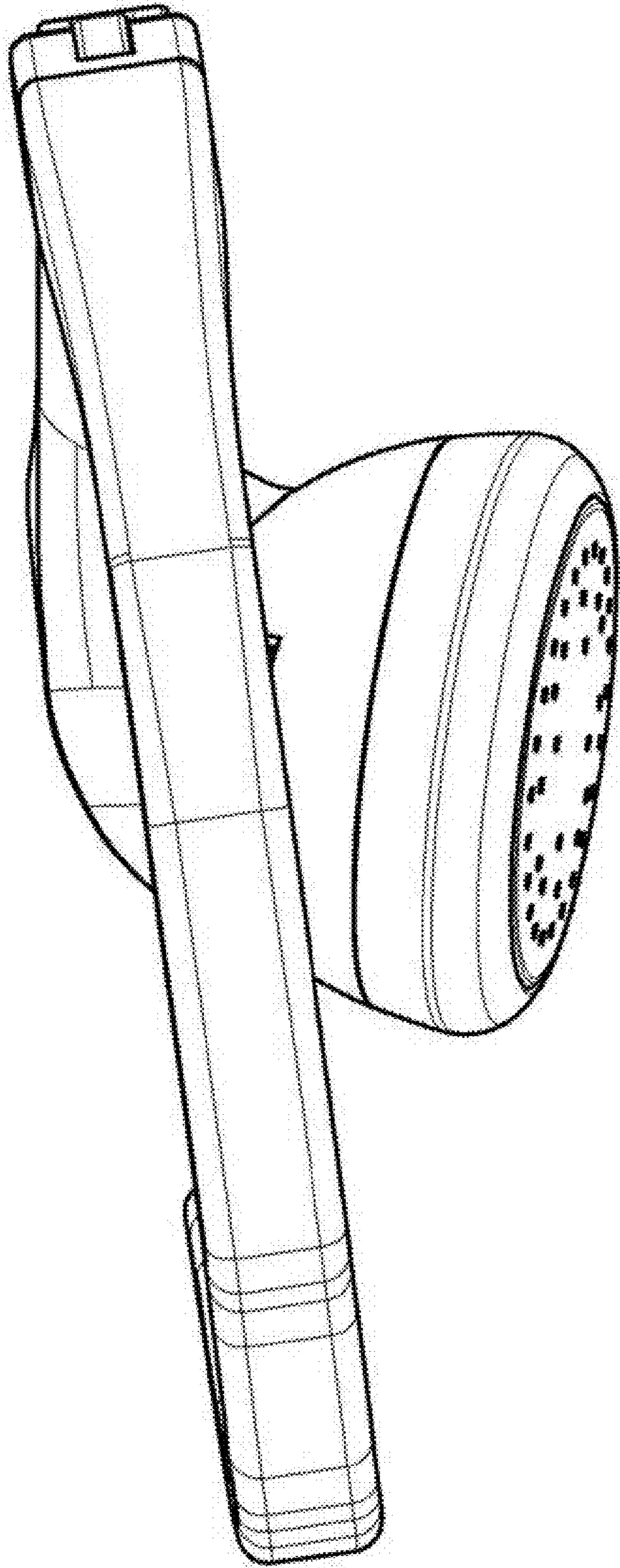


FIG. 2

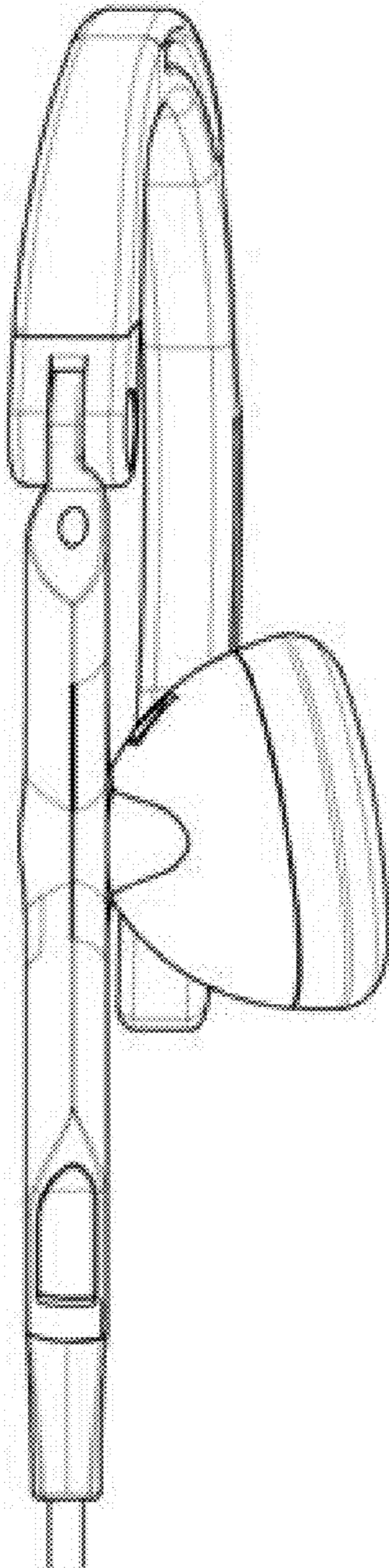


FIG. 3

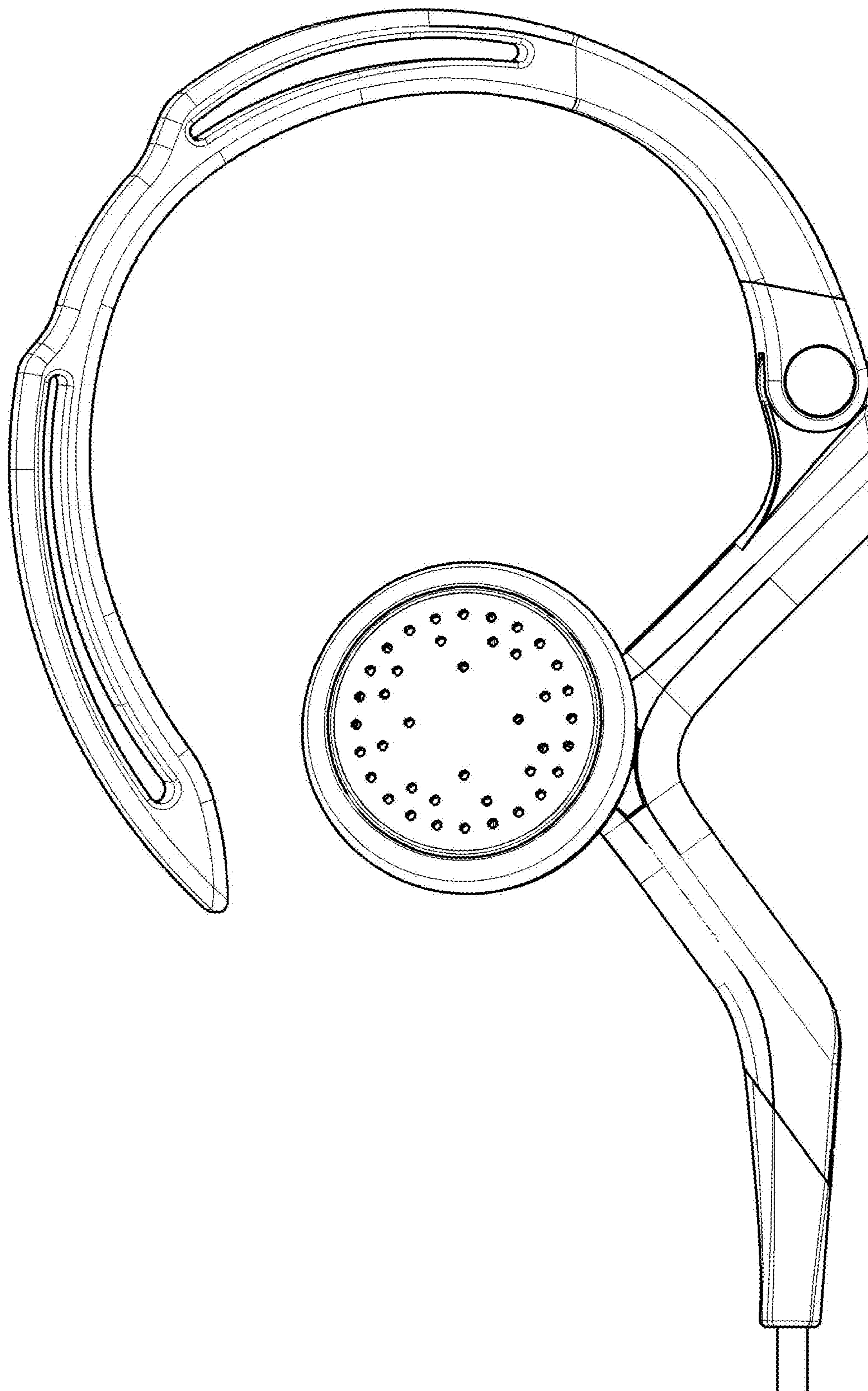


FIG. 4

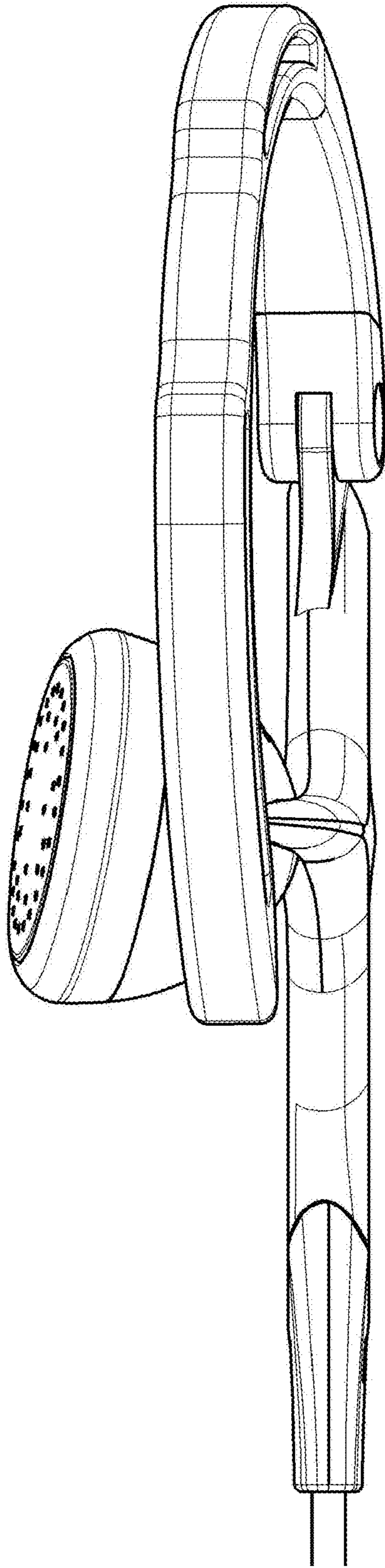


FIG. 5

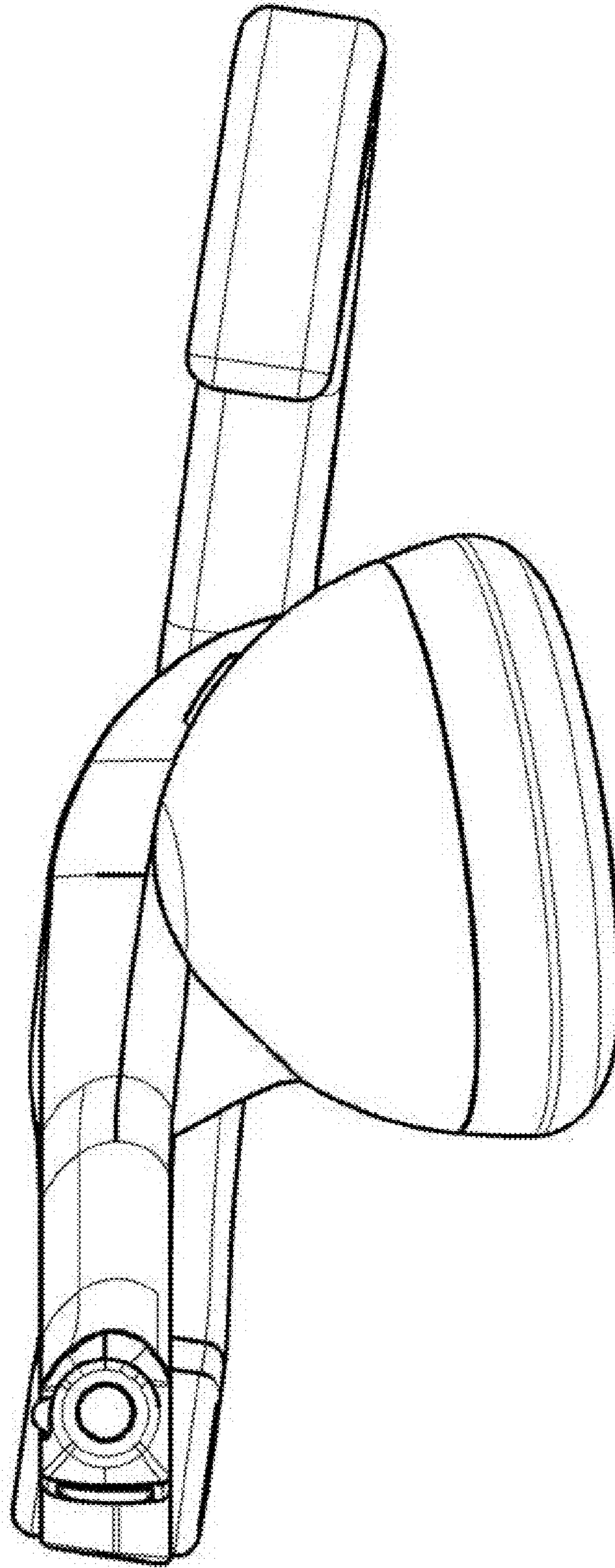


FIG. 6

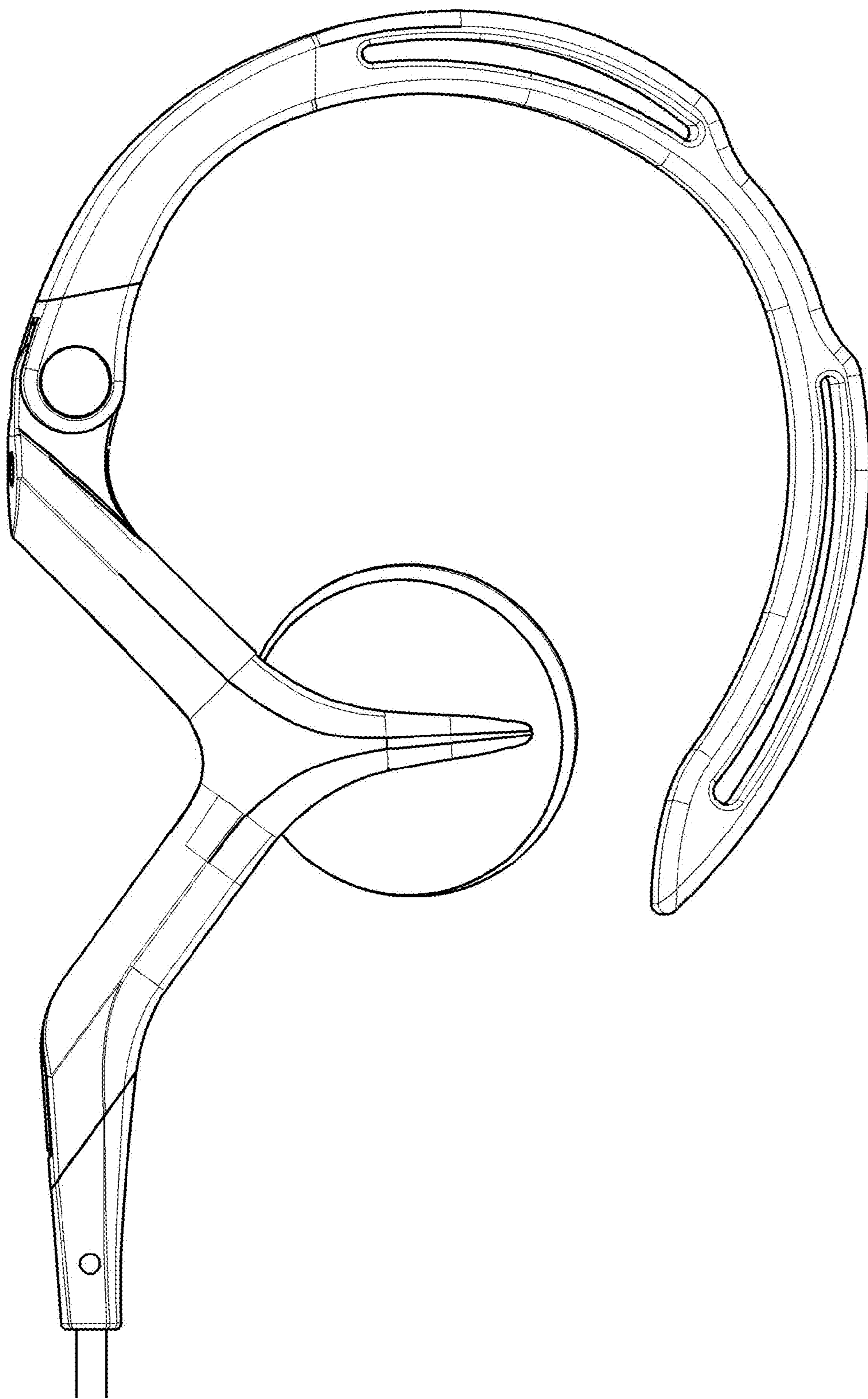


FIG. 7